# Single, Dual, Quad Low Voltage, Rail-to-Rail Operational Amplifiers

The LMV821, LMV822, and LMV824 are operational amplifiers with low input voltage offset and drift vs. temperature. In spite of low quiescent current requirements these devices have 5 MHz bandwidth and 1.4 V/µs slew rate. In addition they provide rail-to-rail output swing into 600  $\Omega$  loads. The input common-mode voltage range includes ground, and the maximum input offset voltage is only 3.5 mV. Substantially large capacitive loads can be driven by simply adding a pullup resistor or isolation resistor.

The LMV821 (single) is available in a space–saving SC70–5 while the dual and quad also come in ultra small SOIC and TSSOP packages.

#### Features

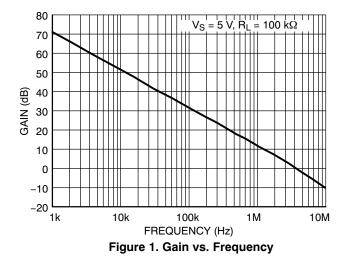
- Low Offset Voltage: 3.5 mV
- Very low Offset Drift: 1.0  $\mu$ V/°C
- High Bandwidth: 5 MHz
- Rail-to-Rail Output Swing into a 600  $\Omega$  load
- Capable of driving highly capacitive loads
- Small Packages:

LMV821 in SC-70 LMV822 in Micro8\* and SOIC-8\* (\*Contact Sales for Package Availability) LMV824 in SOIC-14 and TSSOP-14

• These Devices are Pb-Free and are RoHS Compliant

#### **Typical Applications**

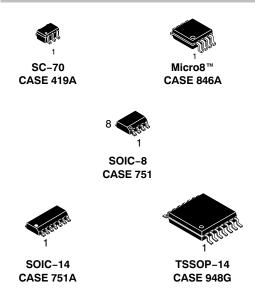
- Notebook Computers
- PDAs
- Modem Transmitter/ Receivers





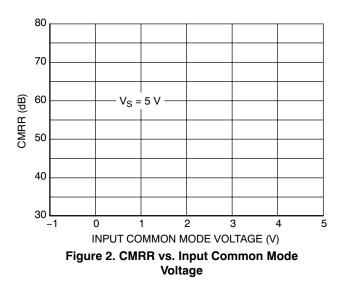
### **ON Semiconductor®**

http://onsemi.com

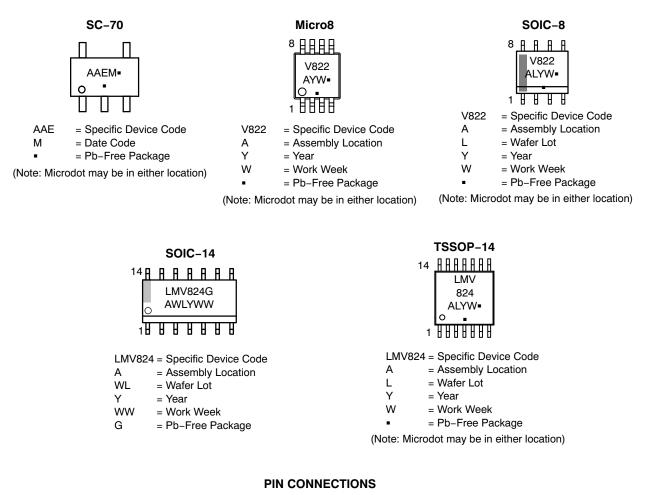


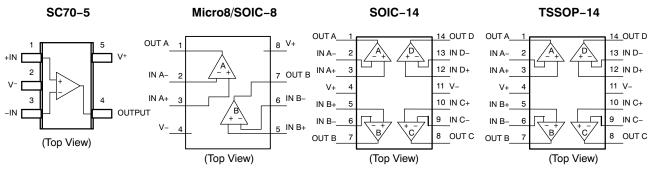
ORDERING AND MARKING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.



#### MARKING DIAGRAMS





#### MAXIMUM RATINGS

Symbol	Rating	Value	Unit
VS	Supply Voltage (Operating Range $V_S = 2.7 \text{ V to } 5.5 \text{ V}$ )	5.5	V
V <sub>IDR</sub>	Input Differential Voltage	$\pm$ Supply Voltage	V
V <sub>ICR</sub>	Input Common Mode Voltage Range	-0.5 to (V+) +0.5	V
	Maximum Input Current	10	mA
t <sub>SO</sub>	Output Short Circuit (Note 1)	Continuous	
TJ	Maximum Junction Temperature (Operating Range –40°C to 85°C)	150	°C
$\theta_{JA}$	Thermal Resistance		°C/W
	SC-70	280	
	Micro8	238	
	SOIC-8	212	
	SOIC-14	156	
	TSSOP-14	190	
T <sub>STG</sub>	Storage Temperature	-65 to 150	°C
	Mounting Temperature (Infrared or Convection – 20 sec)	235	°C
V <sub>ESD</sub>	ESD Tolerance Machine Model Human Body Model	200 2000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. Continuous short-circuit operation to ground at elevated ambient temperature can result in exceeding the maximum allowed junction tem-

 Continuous short-circuit operation to ground at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability. Shorting output to either V+ or Vwill adversely affect reliability.

**2.7V DC ELECTRICAL CHARACTERISTICS** Unless otherwise noted, all min/max limits are guaranteed for  $T_A = 25^{\circ}$ C, V+ = 2.7 V, V- = 0 V,  $V_{CM} = V+/2$ ,  $V_O = V+/2$  and  $R_L > 1 M\Omega$ . Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Offset Voltage	V <sub>IO</sub>			1	3.5	mV
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			4	1
Input Offset Voltage Average Drift	TCV <sub>OS</sub>			1		μV/°C
Input Bias Current	Ι <sub>Β</sub>			105	210	nA
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			315	
Input Offset Current	I <sub>IO</sub>			0.5	30	nA
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			50	]
Common-Mode Rejection	CMRR	$0 \text{ V} \leq \text{V}_{CM} \leq 1.7 \text{ V}$	70	85		dB
Ratio		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	68			
Power Supply Rejection Ratio	PSRR	$\begin{array}{l} 1.5 \; V  \leq  V+  \leq  4 \; V,  V-=-1 \;  V, \; V_O=0 \; V, \\ V_{CM}=0.0 \; V \end{array}$	75	85		dB
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	70			
Input Common–Mode Voltage Range	V <sub>CM</sub>	For CMRR $\ge$ 53 dB and T <sub>A</sub> = -40°C to +85°C	-0.2	-0.3 to 2.0	1.9	V
Large Signal Voltage Gain	AV	$\rm R_L$ = 600 $\Omega,  \rm V_O$ = 0.5 V to 2.5 V	80	95		dB
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	70			
		$R_L$ = 2 kΩ, $V_O$ = 0.5 V to 2.5 V	83	89		]
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	80			
Output Swing	V <sub>OH</sub>	$R_L$ = 600 $\Omega$ to 1.35 V	2.5	2.58		V
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.4			
	V <sub>OL</sub>	$R_L$ = 600 $\Omega$ to 1.35 V		0.13	0.21	
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			0.3	
	V <sub>OH</sub>	$R_L = 2 k\Omega$ to 1.35 V	2.6	2.66		
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$	2.5			
	V <sub>OL</sub>	$R_L = 2 k\Omega$ to 1.35 V		0.08	0.12	
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			0.2	
Output Current	۱ <sub>0</sub>	Sourcing, $V_O = 0 V$	12			mA
		Sinking, V <sub>O</sub> = 2.7 V	12	26		
Supply Current	I <sub>CC</sub>	LMV821 (Single)		0.242	0.3	mA
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.5	]
		LMV822 (Both Applications)		0.5	0.7	
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.9	]
		LMV824 (All Four Applications)		1	1.3	]
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			1.5	]

**2.5V DC ELECTRICAL CHARACTERISTICS** Unless otherwise noted, all min/max limits are guaranteed for  $T_A = 25$  °C, V+ = 2.5 V, V- = 0 V, V<sub>CM</sub> = V+/2, V<sub>O</sub> = V+/2 and R<sub>L</sub> > 1 M\Omega. Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Offset Voltage	V <sub>IO</sub>	$T_A = -40^{\circ}C$ to $+85^{\circ}C$		1	3.5	mV
					4	]
Output Swing	V <sub>OH</sub>	$\rm R_L$ = 600 $\Omega$ to 1.25 V	2.3	2.37		V
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	2.2			
	V <sub>OL</sub>	$\rm R_L$ = 600 $\Omega$ to 1.25 V		0.13	0.20	
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.3	1
	V <sub>OH</sub>	$R_L = 2 \text{ k}\Omega \text{ to } 1.25 \text{ V}$	2.4	2.46		
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	2.3			
	V <sub>OL</sub>	$R_L = 2 \text{ k}\Omega \text{ to } 1.25 \text{ V}$		0.08	0.12	
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.20	1

**2.7V AC ELECTRICAL CHARACTERISTICS** Unless otherwise specified, all limits are guaranteed for  $T_A = 25^{\circ}C$ ,  $V_{+} = 2.7$  V,  $V_{-} = 0$  V,  $V_{CM} = 1.0$  V,  $V_O = V_{+}/2$  and RL > 1 M $\Omega$ . Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Slew Rate	SR	(Note 2)		1.5		V/uS
Gain Bandwidth Product	GBWP			5		MHz
Phase Margin	$\theta_{m}$			55		0
Gain Margin	G <sub>m</sub>			12.9		dB
Input-Referred Voltage Noise	e <sub>n</sub>	f = 1 kHz, V <sub>CM</sub> = 1 V		12		nV/√Hz
Input-Referred Current Noise	i <sub>n</sub>	f = 1kHz		0.2		pA/√Hz
Total Harmonic Distortion	THD	f = 1 kHz, AV = –2, R <sub>L</sub> = 10 k $\Omega$ , V <sub>O</sub> = 1.8 V <sub>PP</sub>		0.023		%
Amplifier-to-Amplifier Isolation		(Note 3)		135		dB

2. Connected as voltage follower with input step from 0.5 V to 1.5 V. Number specified is the average of the positive and negative slew rates.

3. Input referred,  $R_L = 100 \text{ k}\Omega$  connected to V+/2. Each amp excited in turn with 1kHz to produce  $V_O = 3 \text{ V}_{PP}$ . For Supply Voltages < 3 V,  $V_O = V_+$ .

**5V DC ELECTRICAL CHARACTERISTICS** Unless otherwise noted, all min/max limits are guaranteed for  $T_A = 25^{\circ}$ C, V+ = 5 V,V- = 0 V, VCM = V+/2, V<sub>O</sub> = V+/2 and R<sub>L</sub> > 1 M $\Omega$ . Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

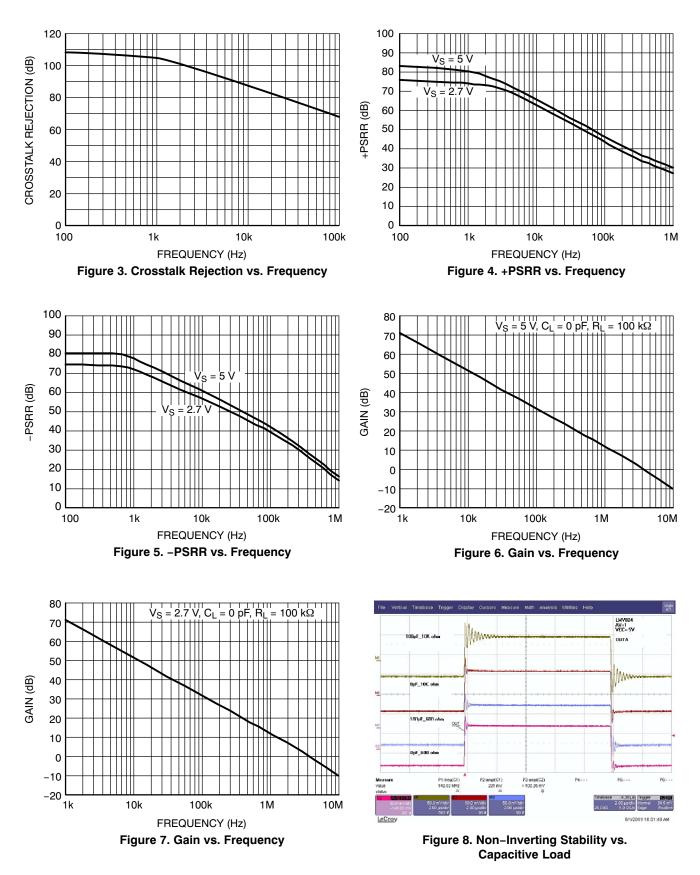
Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Input Offset Voltage	V <sub>IO</sub>			1	3.5	mV
	Γ	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			4	
Input Offset Voltage Average Drift	TCV <sub>OS</sub>			1		μV/°C
Input Bias Current	Ι <sub>Β</sub>			119	245	nA
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			380	1
Input Offset Current	I <sub>IO</sub>			0.5	30	nA
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			50	1
Common-Mode Rejection	CMRR	$0~V~\leq~V_{CM}~\leq~4.0~V$	72	90		dB
Ratio	Γ	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	70			
Power Supply Rejection Ratio	PSRR	$\begin{array}{l} 1.7 \; V  \leq  V+  \leq  4 \; V,  V-=1 \; V,  V_O=0 \; V, \\ V_{CM}=0.0 \; V \end{array}$	75	85		dB
	Γ	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	70			
Input Common–Mode Voltage Range	V <sub>CM</sub>	For CMRR $\ge$ 58 dB and T <sub>A</sub> = - 40°C to +85°C	-0.2	-0.2 to 4.3	4.2	V
Large Signal Voltage Gain	Av	$R_L$ = 600 $\Omega$ , $V_O$ = 1.0 V to 4.0 V	87	100		dB
	Γ	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	73			
		$R_L$ = 2 kΩ, $V_O$ = 1.0 V to 4.0 V	84	99		
	Γ	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	82			
Output Swing	V <sub>OH</sub>	$\rm R_L$ = 600 $\Omega$ to 2.5 V	4.75	4.84		V
	Γ	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	4.7			
	V <sub>OL</sub>	$\textrm{R}_{\textrm{L}}$ = 600 $\Omega$ to 2.5 V		0.17	0.33	1
	Γ	$T_A = -40^{\circ}C$ to $+85^{\circ}C$			0.4	
	V <sub>OH</sub>	RL = 2 k $\Omega$ to 2.5 V	4.85	4.9		
	Γ	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	4.8			
	V <sub>OL</sub>	$R_L$ = 2 k $\Omega$ to 2.5 V		0.1	0.15	
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.2	
Output Current	Ι <sub>Ο</sub>	Sourcing, Vo = 0 V	20	45		mA
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	10			
		Sinking, Vo = 5 V	20	40		
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	15			
Supply Current	Icc			0.3	0.4	mA
		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			0.6	1
		LMV822 (Both Applications)		0.5	0.7	1
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			0.9	1
		LMV824 (All Four Applications)		1	1.3	1
		$T_A = -40^{\circ}C$ to $+85^{\circ}C$			1.5	1

**5V AC ELECTRICAL CHARACTERISTICS** Unless otherwise specified, all limits are guaranteed for  $T_A = 25^{\circ}C$ ,  $V_{+} = 5$  V,  $V_{-} = 0$  V,  $V_{CM}$  = 2.0 V,  $V_0$  = V+/2 and  $R_L$  > 1 M $\Omega$ . Typical specifications represent the most likely parametric norm. Min/Max specifications are guaranteed by testing, characterization, or statistical analysis.

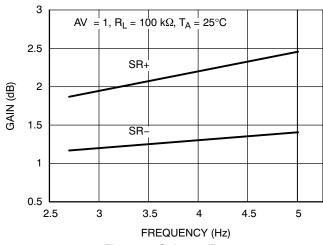
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Slew Rate	SR	(Note 4)		2		V/µS
Gain Bandwidth Product	GBWP			5.6		MHz
Phase Margin	θm			63		0
Gain Margin	G <sub>m</sub>			11.7		dB
Input-Referred Voltage Noise	e <sub>n</sub>	f = 1 kHz, V <sub>CM</sub> = 1 V		11		nV/√Hz
Input-Referred Current Noise	i <sub>n</sub>	f = 1 kHz		0.21		pA/√Hz
Total Harmonic Distortion	THD	f = 1 kHz, A <sub>V</sub> = –2, R <sub>L</sub> = 10 k $\Omega$ , V <sub>O</sub> = 4.11 VPP		0.012		%
Amplifier-to-Amplifier Isolation		(Note 5)		135		dB

4. Connected as voltage follower with input step from 0.5 V to 3.5 V. Number specified is the average of the positive and negative slew rates.
5. Input referred, R<sub>L</sub> = 100 kΩ connected to V+/2. Each amp excited in turn with 1 kHz to produce V<sub>O</sub> = 3 V<sub>PP</sub>. (For Supply Voltages < 3 V, V<sub>O</sub> = V+).

### **TYPICAL PERFORMANCE CHARACTERISTICS**



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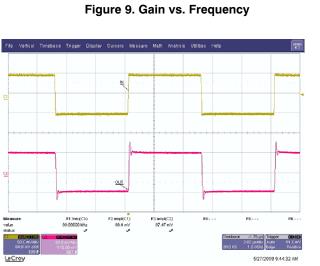


Figure 11. Non–Inverting Small Signal Step Response

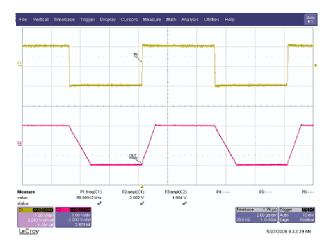
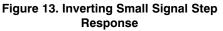


Figure 10. Non–Inverting Large Signal Step Response

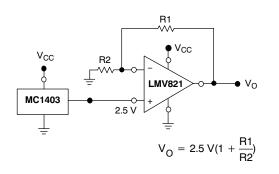


#### Figure 12. Inverting Large Signal Step Response

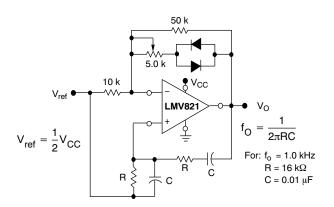




#### **APPLICATIONS INFORMATION**









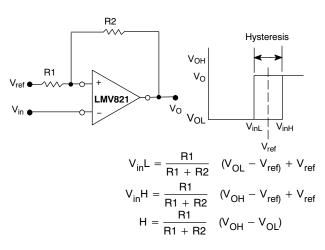
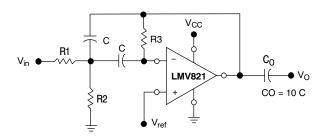
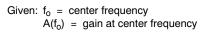


Figure 16. Comparator with Hysteresis





Choose value f<sub>o</sub>, C  
Then: R3 = 
$$\frac{Q}{\pi f_O C}$$
  
R1 =  $\frac{R3}{2 A(f_O)}$   
R2 =  $\frac{R1 R3}{4Q^2 R1 - R3}$ 

For less than 10% error from operational amplifier, ((Q<sub>Q</sub>  $f_0$ )/BW) < 0.1 where  $f_0$  and BW are expressed in Hz. If source impedance varies, filter may be preceded with voltage follower buffer to stabilize filter parameters.

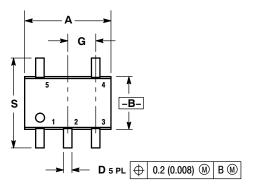
#### Figure 17. Multiple Feedback Bandpass Filter

#### **ORDERING INFORMATION**

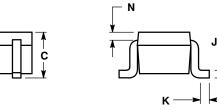
Order Number	Number of Channels	Specific Device Marking	Package Type	Shipping <sup>†</sup>
LMV821SQ3T2G	Single	AAE	SC–70 (Pb–Free)	3000 / Tape & Reel
LMV822DMR2G*	Dual	V822	Micro8 (Pb–Free)	4000 / Tape & Reel
LMV822DR2G*	Dual	V822	SOIC-8 (Pb-Free)	2500 / Tape & Reel
LMV824DR2G	Quad	LMV824	SOIC-14 (Pb-Free)	2500 / Tape & Reel
LMV824DTBR2G	Quad	LMV 824	TSSOP-14 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 \*Contact sales for package availability.

SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE K



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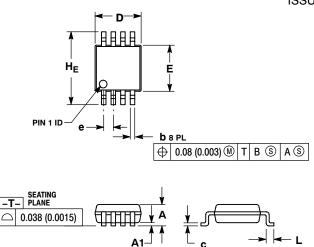


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 419A-01 OBSOLETE. NEW STANDARD 419A-02. 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INC	HES	MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026	BSC	0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
Κ	0.004	0.012	0.10	0.30
Ν	0.008 REF		0.20	REF
S	0.079	0.087	2.00 2.20	

#### PACKAGE DIMENSIONS

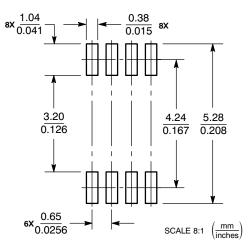
Micro8<sup>TM</sup> CASE 846A-02 **ISSUE H** 



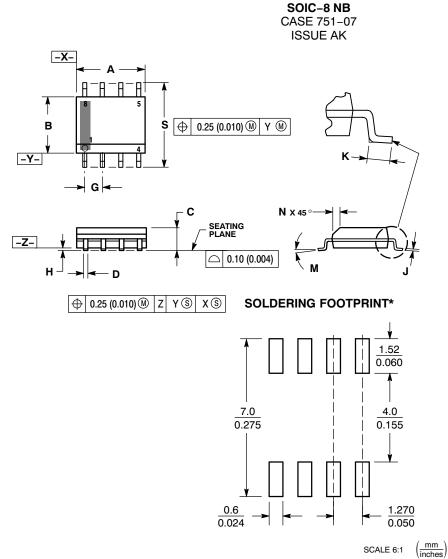
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 4.
- 5. 846A-01 OBSOLETE, NEW STANDARD 846A-02.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.05	0.08	0.15	0.002	0.003	0.006
b	0.25	0.33	0.40	0.010	0.013	0.016
С	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
Е	2.90	3.00	3.10	0.114	0.118	0.122
e	0.65 BSC				0.026 BSC	)
L	0.40	0.55	0.70	0.016	0.021	0.028
ΗE	4.75	4.90	5.05	0.187	0.193	0.199

#### **SOLDERING FOOTPRINT\***



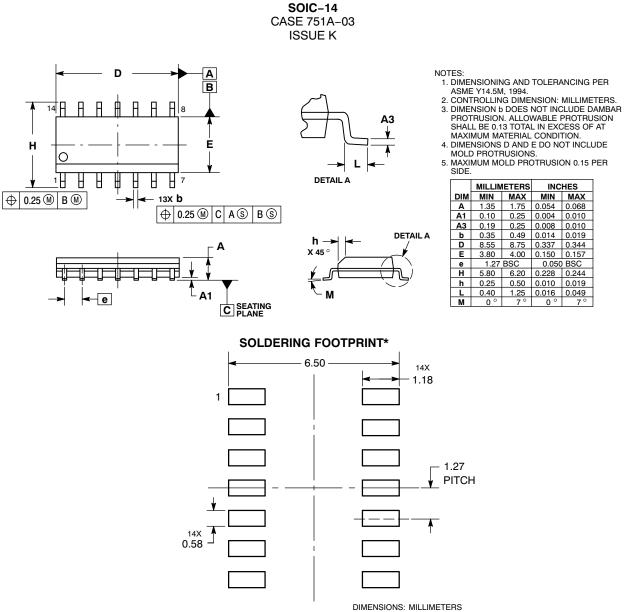
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

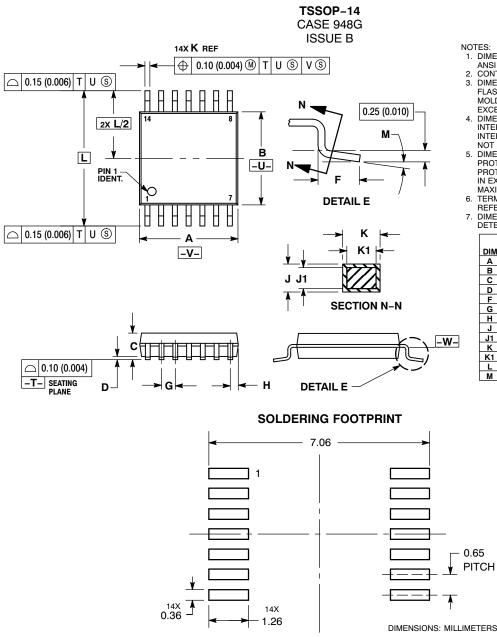
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.
- 3.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE. 4.
- PER SIDE. 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION. 6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIN	IETERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
Α	4.80	5.00	0.189	0.197				
в	3.80	4.00	0.150	0.157				
С	1.35	1.75	0.053	0.069				
D	0.33	0.51	0.013	0.020				
G	1.27	7 BSC	0.050 BSC					
Н	0.10	0.25	0.004	0.010				
J	0.19	0.25	0.007	0.010				
к	0.40	1.27	0.016	0.050				
М	0 °	8 °	0 °	8 °				
Ν	0.25	0.50	0.010	0.020				
S	5.80	6.20	0.228	0.244				



\*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



1. DIMENSIONING AND TOLERANCING PER

- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION. TERMINAL NUMBERS ARE SHOWN FOR
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026 BSC	
н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
Μ	0 °	8 °	0 °	8 °

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